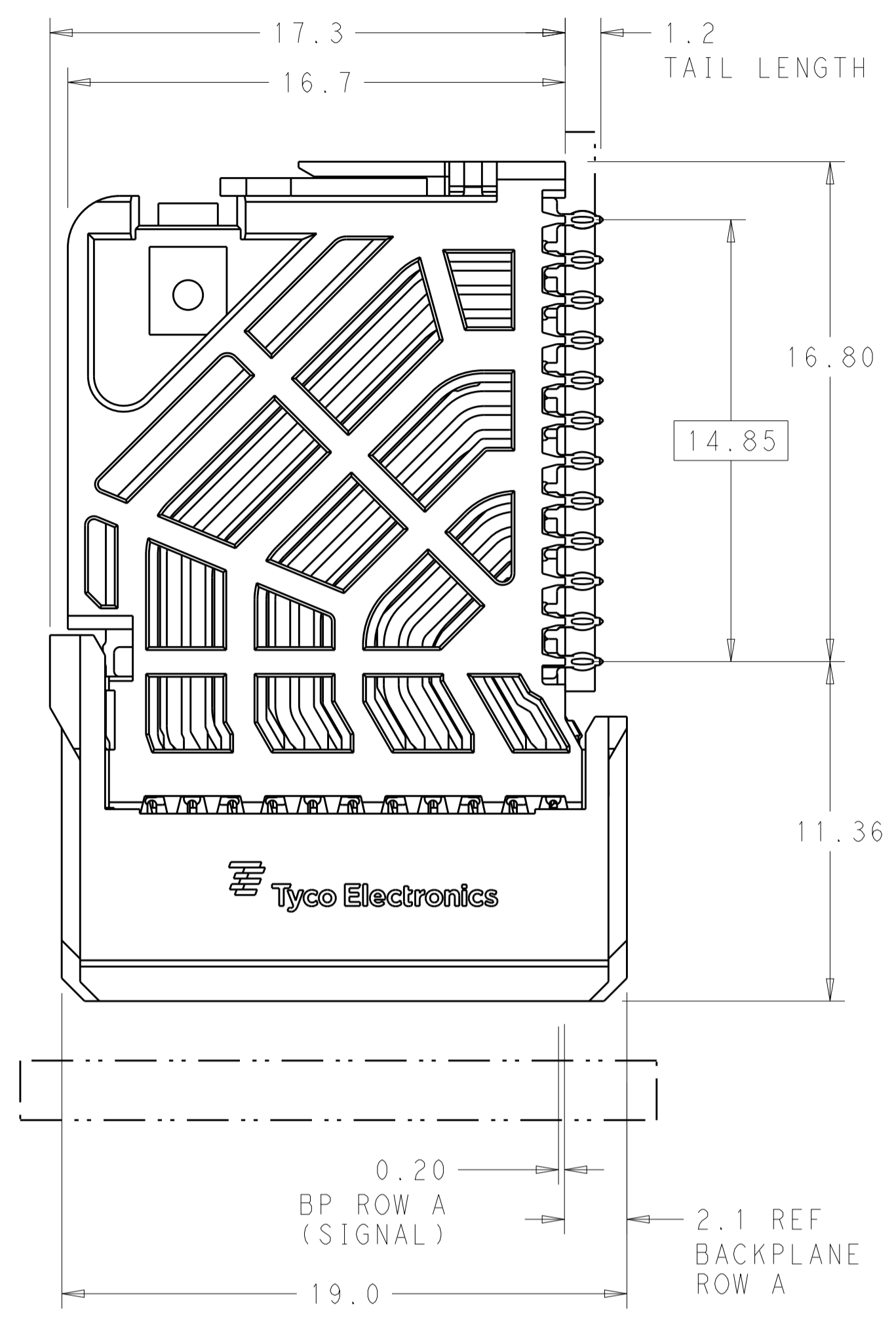
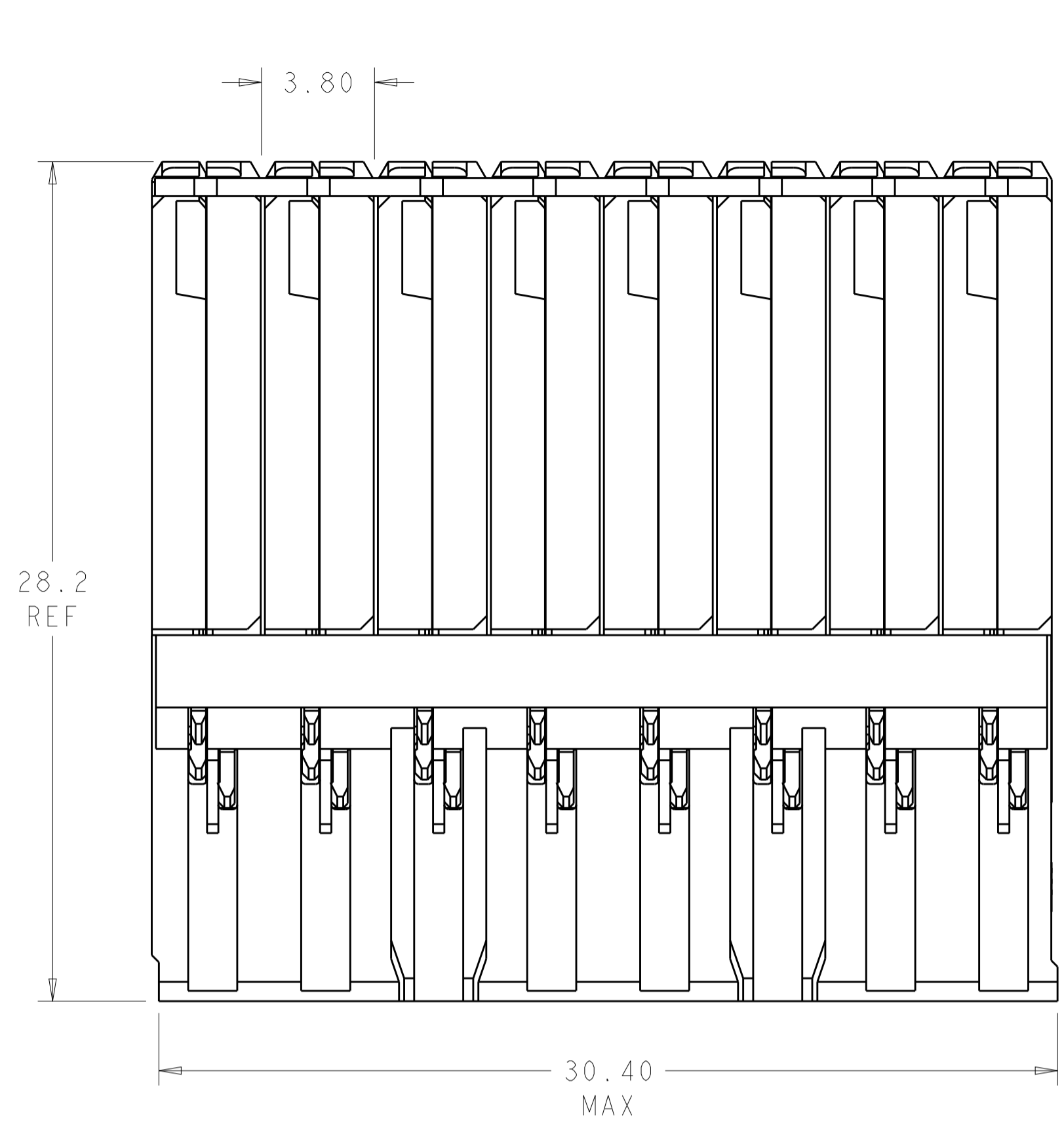
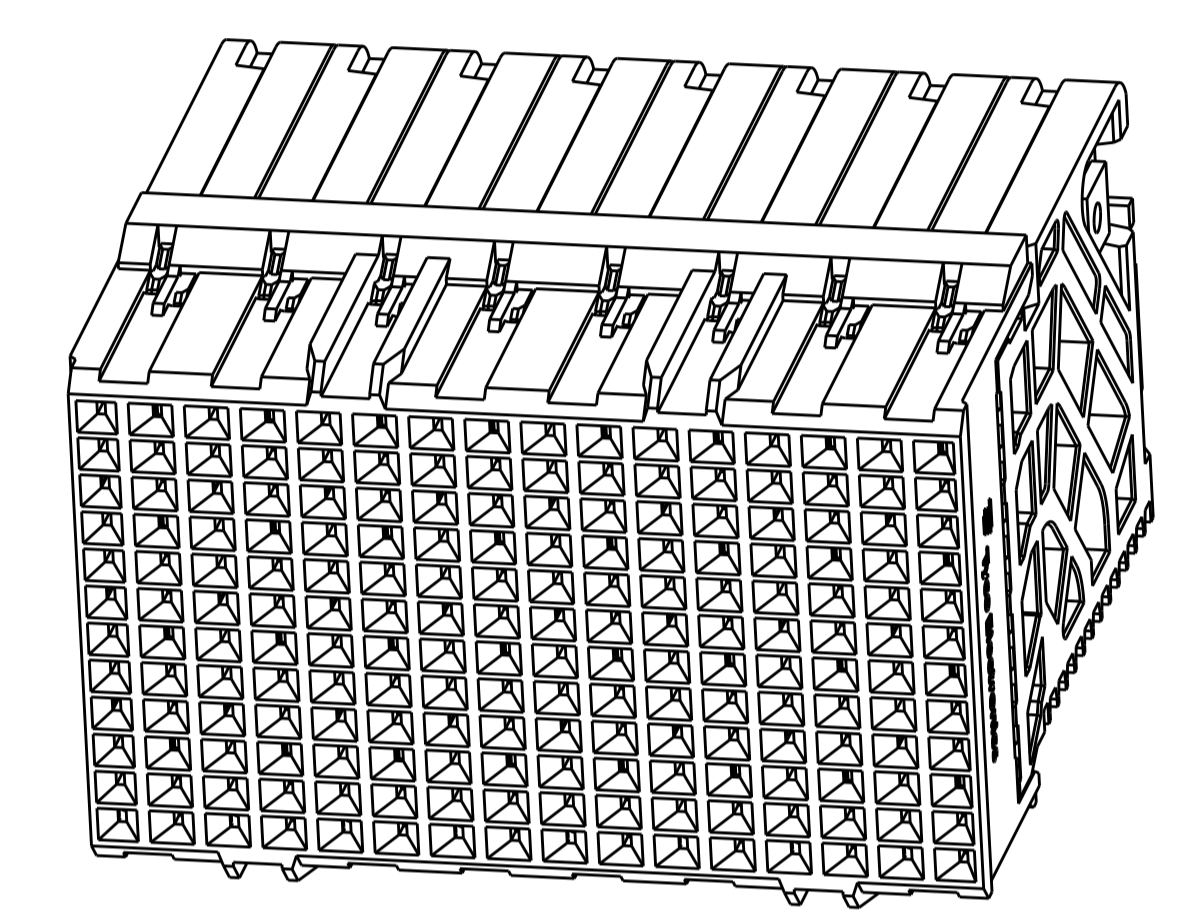


LOC		DIST		REVISIONS			
AD	00	P	LTN	DESCRIPTION	DATE	DWN	APVD
		B1		REVISED PER ECO-14-018036	17FEB2015	AP	DD



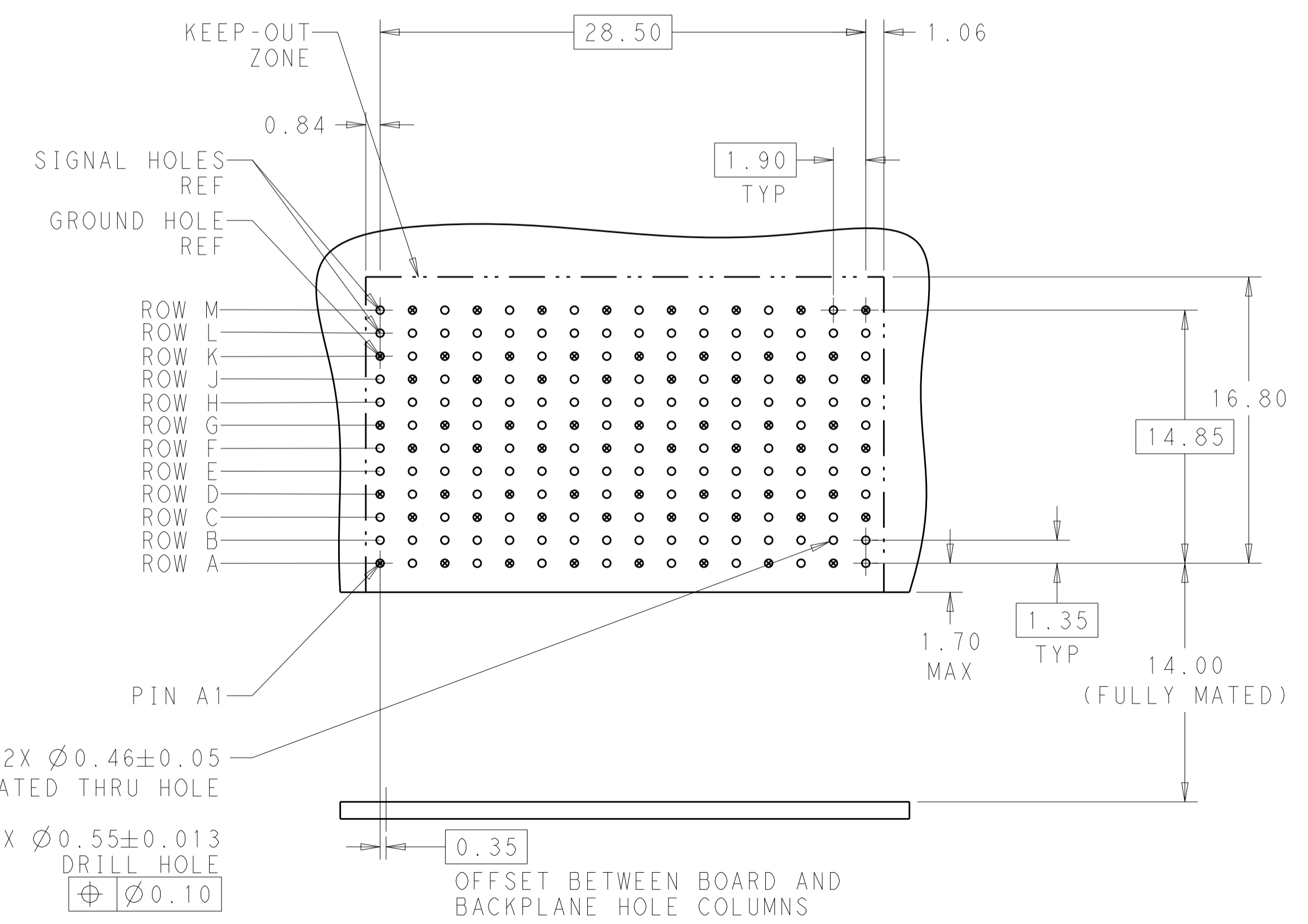
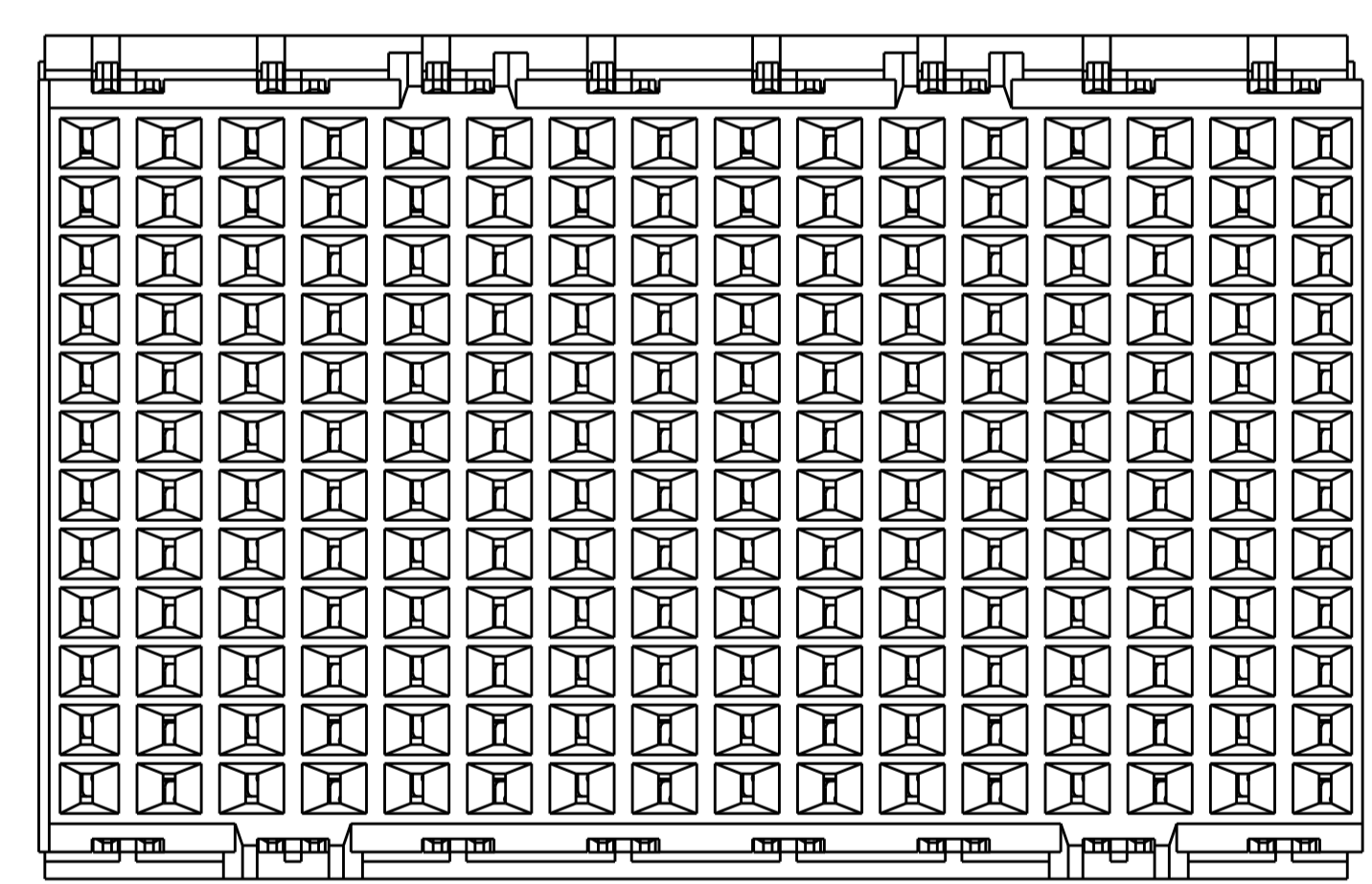
⚠ MATERIAL:  
HOUSING: LCP, GLASS FILLED, UL94V-0.  
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.

⚠ FINISH:  
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.



SCALE 4:1

REFER TO WWW.TE.COM FOR PRODUCT AVAILABILITY



192X Ø0.46±0.05 PLATED THRU HOLE  
192X Ø0.55±0.013 DRILL HOLE  
Ø0.10

OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT  
MIN BOARD THICKNESS 1.0

NONE	⚠	2007720-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: 18MAY2011	TE Connectivity
DIMENSIONS: mm		CHK: D. DIXON 18MAY2011	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: D. DIXON 18MAY2011	
0 PLC ± 1 PLC ±0.2 2 PLC ±0.13 3 PLC ± 4 PLC ± ANGLES ±		NAME: IMPACT, 4 PAIR, DAUGHTERCARD 16 COLUMN, UNGUIDED, SIGNAL MODULE, 0.46 EYELET	
MATERIAL: ⚠	FINISH: SEE TABLE	WEIGHT: -	RESTRICTED TO: -
CUSTOMER DRAWING		SIZE: A1	SCALE: 6:1